

江西晶亮光电科技协同创新有限公司

JiangXi JingLiang Sci &Tech Corporation

产 品 规 格 书

Specification

产品名称 Product Name: Chip Scale Package

产品型号 Product P/N: CSP1717-J

客 户 Client name: _____

客户料号 Client P/N: _____

版 本 号 Version No.: V1.1

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客户承认栏 Client Approval	
核准 Approval	确认 Audit

制定 Confirmation: _____ 审核 Approval: _____

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1、特点 Features

- ◆ 小尺寸封装，高亮度，高光效
Small footprint package , High brightness ,High efficiency
- ◆ 尺寸：1.70*1.70*0.32mm，单面发光
Size: 1.70*1.70*0.32mm, 1-sided emitter
- ◆ 根据 ANSI 标准分档
According to the ANSI standard colour gamut
- ◆ 适于 SMT 贴片
Compatible with SMT
- ◆ 发光角度：120°
Viewing Angle: 120°
- ◆ 包装：最大 5000 颗/卷
Package: Max: 5000pcs /reel



2、应用 Applications

背光

Back Light



3、性能 Performance

a) 绝对最大额定值 Absolute Maximum Ratings

参数 Parameter	符号 Symbol	最大参数值 Maximum Rating	单位 Unit
电流 DC (Video Mode) Forward Current	I_F	400	mA
功率 Power Dissipation	P	1.2	W
脉冲电流 Pulsed(Flash Mode) Forward Current	I_{FP}	1000	mA
结温 (DC 模式) LED Junction Temperature (DC mode)	T_j	135	°C
反向电压 Reverse Voltage	V_R	5	V
工作温度 Operating Temperature Range	T_{opr}	-40~105	°C
存储温度 Storage Temperature	T_{stg}	-40~120	°C
ESD (人体模式) ESD Human Body Mode	----	2000	V

备注 Notes :

✧ 绝对最大额定值环境温度 $T_a=25^{\circ}\text{C}$

Absolute Maximum Ratings at $T_a=25^{\circ}\text{C}$

✧ I_{FP} 脉冲时间 $\leq 10\text{ms}$, 宽度 $\leq 10\%$

I_{FP} Conditions with pulse width $\leq 10\text{ms}$ and duty cycle $\leq 10\%$

b) 光电参数

Electro-Optical Characteristics (T solder pad =85 °C, I_F =60mA)

项目 Item	符号 Symbol	最小值 Min.	典型值 Typ.	最大值 Max.	单位 Unit
光通量 Luminous Flux	Φ	----	28	----	Lm
正向电压 Forward Voltage	VF	2.6	2.9	3.2	V
色温 CCT	----	----	10000	----	K
显指 Ra	----	----	----	----	----
热阻 Thermal Resistance	----	----	1~3	----	°C/W
发光角度 Viewing Angle	2θ1/2	----	120	----	°
结温 LED Junction Temperature	T _j	----	135	----	°C

备注 Notes :

- ◇ 光通量测量误差范围±7%
Luminous flux measurement tolerance: ±7%
- ◇ 光电参数测试是瞬态时间为 20ms
Electric and optical data is tested at 20 ms pulse condition

4. 产品代码 Product Order Code

17 - SD1 - FF - 00 - A2 - BD
 ① ② ③ ④ ⑤ ⑥

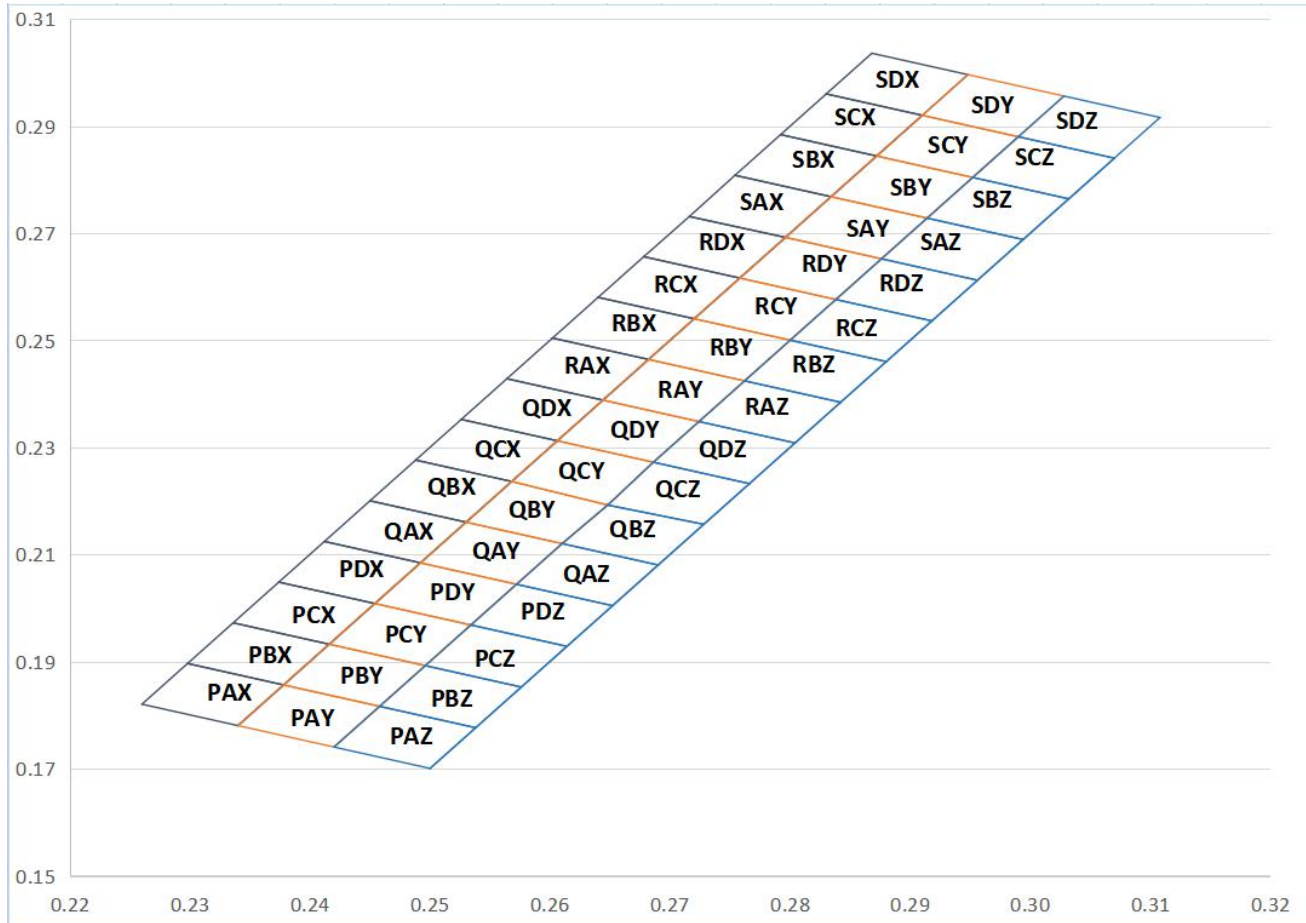
- ① 产品型号 Product Type
- ② 色区 Colour Area
- ③ 亮度等级 Brightness Level
- ④ 显色指数 Ra level (无要求的代码为 00)
- ⑤ 电压等级 VF Level
- ⑥ 内部波长代码 (不影响其他参数, 不用参考)
 Internal Wavelength Code (Do not affect other parameters)

出货标签(例) Shipping label (e.g.)



5. 分档规则 Bin Regulations

a) 色度区域 Chromaticity Regions



色块	X	Y
SDX	0.291	0.292
	0.2948	0.2996
	0.2868	0.3036
	0.283	0.296
SCX	0.2872	0.2844
	0.291	0.292
	0.283	0.296
	0.2792	0.2884
SBX	0.2834	0.2768
	0.2872	0.2844
	0.2792	0.2884
	0.2754	0.2808
SAX	0.2796	0.2692
	0.2834	0.2768
	0.2754	0.2808
	0.2716	0.2731
色块	X	Y
RDX	0.2758	0.2616
	0.2796	0.2692
	0.2716	0.2731
	0.2678	0.2656
RCX	0.272	0.254
	0.2758	0.2616
	0.2678	0.2656
	0.264	0.258
RBX	0.2682	0.2464
	0.272	0.254
	0.264	0.258
	0.2602	0.2504
RAX	0.2644	0.2388
	0.2682	0.2464
	0.2602	0.2504
	0.2564	0.2428

色块	X	Y
SDY	0.299	0.288
	0.3028	0.2956
	0.2948	0.2996
	0.291	0.292
SCY	0.2952	0.2804
	0.299	0.288
	0.291	0.292
	0.2872	0.2844
SBY	0.2914	0.2728
	0.2952	0.2804
	0.2872	0.2844
	0.2834	0.2768
SAY	0.2876	0.2652
	0.2914	0.2728
	0.2834	0.2768
	0.2796	0.2692
色块	X	Y
RDY	0.2838	0.2576
	0.2876	0.2652
	0.2796	0.2692
	0.2758	0.2616
RCY	0.28	0.25
	0.2838	0.2576
	0.2758	0.2616
	0.272	0.254
RBY	0.2762	0.2424
	0.28	0.25
	0.272	0.254
	0.2682	0.2464
RAY	0.2724	0.2348
	0.2762	0.2424
	0.2682	0.2464
	0.2644	0.2388

色块	X	Y
SDZ	0.307	0.284
	0.3108	0.2916
	0.3028	0.2956
	0.299	0.288
SCZ	0.3032	0.2764
	0.307	0.284
	0.299	0.288
	0.2952	0.2804
SBZ	0.2994	0.2688
	0.3032	0.2764
	0.2952	0.2804
	0.2914	0.2728
SAZ	0.2956	0.2612
	0.2994	0.2688
	0.2914	0.2728
	0.2876	0.2652
色块	X	Y
RDZ	0.2918	0.2536
	0.2956	0.2612
	0.2876	0.2652
	0.2838	0.2576
RCZ	0.288	0.246
	0.2918	0.2536
	0.2838	0.2576
	0.28	0.25
RBZ	0.2842	0.2384
	0.288	0.246
	0.28	0.25
	0.2762	0.2424
RAZ	0.2804	0.2308
	0.2842	0.2384
	0.2762	0.2424
	0.2724	0.2348

色块	X	Y
QDX	0.2606	0.2312
	0.2644	0.2388
	0.2564	0.2428
	0.2526	0.2352
QCX	0.2568	0.2236
	0.2606	0.2312
	0.2526	0.2352
	0.2488	0.2276
QBX	0.253	0.216
	0.2568	0.2236
	0.2488	0.2276
	0.245	0.22
QAX	0.2492	0.2084
	0.253	0.216
	0.245	0.22
	0.2412	0.2124
色块	X	Y
PDX	0.2454	0.2008
	0.2492	0.2084
	0.2412	0.2124
	0.2374	0.2048
PCX	0.2416	0.1932
	0.2454	0.2008
	0.2374	0.2048
	0.2336	0.1972
PBX	0.2378	0.1856
	0.2416	0.1932
	0.2336	0.1972
	0.2298	0.1896
PAX	0.234	0.178
	0.2378	0.1856
	0.2298	0.1896
	0.226	0.182

色块	X	Y
QDY	0.2686	0.2272
	0.2724	0.2348
	0.2644	0.2388
	0.2606	0.2312
QCY	0.2648	0.2192
	0.2686	0.2272
	0.2606	0.2312
	0.2568	0.2236
QBY	0.261	0.212
	0.2648	0.2192
	0.2568	0.2236
	0.253	0.216
QAY	0.2572	0.2044
	0.261	0.212
	0.253	0.216
	0.2492	0.2084
色块	X	Y
PDY	0.2534	0.1968
	0.2572	0.2044
	0.2492	0.2084
	0.2454	0.2008
PCY	0.2496	0.1892
	0.2534	0.1968
	0.2454	0.2008
	0.2416	0.1932
PBY	0.2458	0.1816
	0.2496	0.1892
	0.2416	0.1932
	0.2378	0.1856
PAY	0.242	0.174
	0.2458	0.1816
	0.2378	0.1856
	0.234	0.178

色块	X	Y
QDZ	0.2766	0.2232
	0.2804	0.2308
	0.2724	0.2348
	0.2686	0.2272
QCZ	0.2728	0.2156
	0.2766	0.2232
	0.2686	0.2272
	0.2648	0.2192
QBZ	0.269	0.208
	0.2728	0.2156
	0.2648	0.2192
	0.261	0.212
QAZ	0.2652	0.2004
	0.269	0.208
	0.261	0.212
	0.2572	0.2044
色块	X	Y
PDZ	0.2614	0.1928
	0.2652	0.2004
	0.2572	0.2044
	0.2534	0.1968
PCZ	0.2576	0.1852
	0.2614	0.1928
	0.2534	0.1968
	0.2496	0.1892
PBZ	0.2538	0.1776
	0.2576	0.1852
	0.2496	0.1892
	0.2458	0.1816
PAZ	0.25	0.17
	0.2538	0.1776
	0.2458	0.1816
	0.242	0.174

备注 Notes :

✧ 色度坐标 (x, y) 来自 CIE1931 色度图

The chromaticity coordinates(x,y)is derived from the CIE 1931 chromaticity diagram

✧ PT86 测试设备用于光通量 (lm) 和 CIE1931 色度坐标 (x, y) 测试。

PT86 is for the luminous flux(lm) and the CIE1931 chromaticity coordinates(x,y) testing.

✧ 色度坐标 (x, y) 存在±0.006 公差。

The chromaticity coordinates(x,y) guarantee should be added ±0.006 tolerance.

b) 亮度分档 Luminous Flux Groups (T solder pad = 25°C, I_F =60 mA)

BIN code	最小值 Min.(lm)	最大值 Max.(lm)
DF	25.5	27
EF	27	28.5
FF	28.5	30
AG	30	32
BG	32	34
CG	34	36

c) 电压分档 Voltage Groups (T solder pad = 25°C, I_F =60 mA)

代码 Group Code	范围 Range
A1	2.6-2.7
A2	2.7-2.8
A3	2.8-2.9
A4	2.9-3.0
A5	3.0-3.1
A6	3.1-3.2

备注 Notes :

✧ 亮度测试存在±7%的公差

It maintains a tolerance of ±7% on luminous flux measurements.

d) 内部代码

Internal Groups

代码 Group Code	范围 Range
S	445~447.5
T	447.5~450
U	450~452.5
V	452.5~455

备注 Notes :

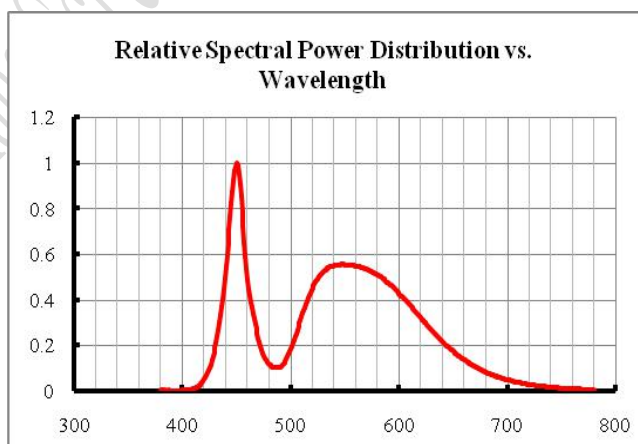
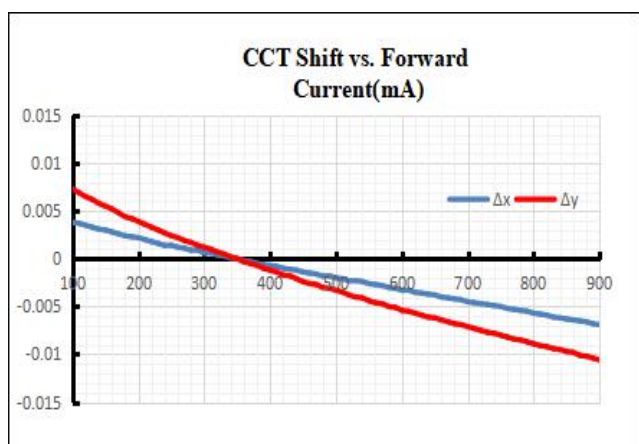
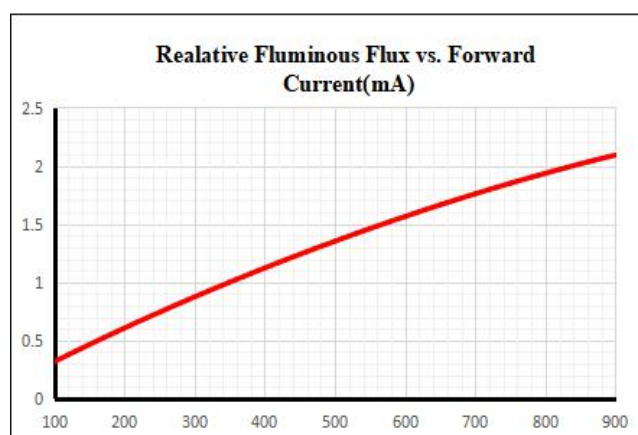
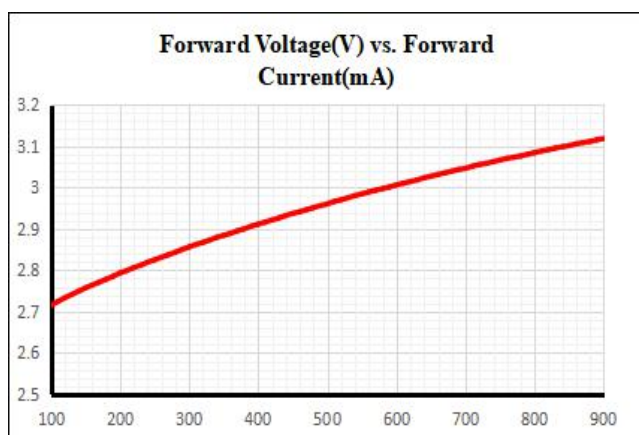
✧ 显指测试存在 ± 2 的公差It maintains a tolerance of ± 2 on CRI measurements

✧ 内部波长代码（不影响其他参数）

Internal Wavelength Code (Do not affect other parameters) .

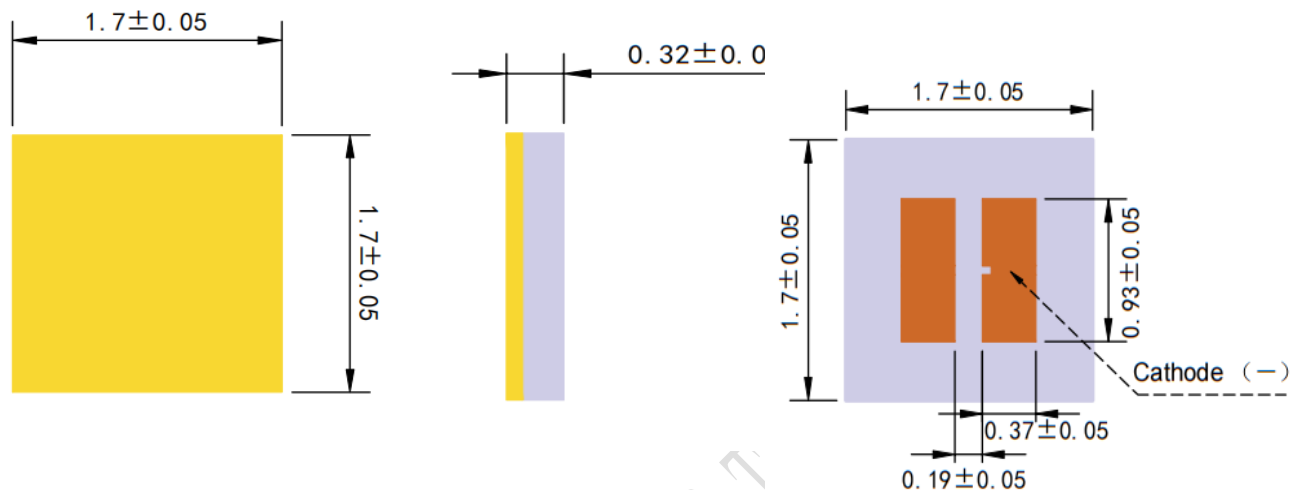
6、光电特性图

The Photoelectric Characteristics Graph ($T_a = 25\text{ }^{\circ}\text{C}$)

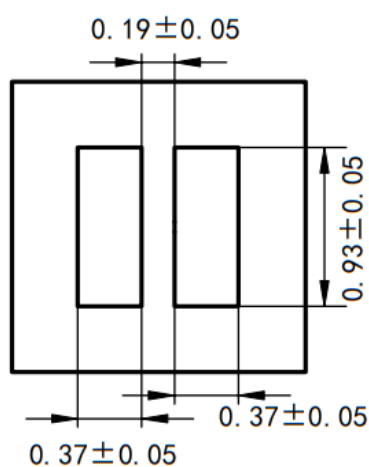


7 产品及钢网尺寸 Product and PCB Pad Dimensions

Product Dimensions:



PCB Pad Dimensions:

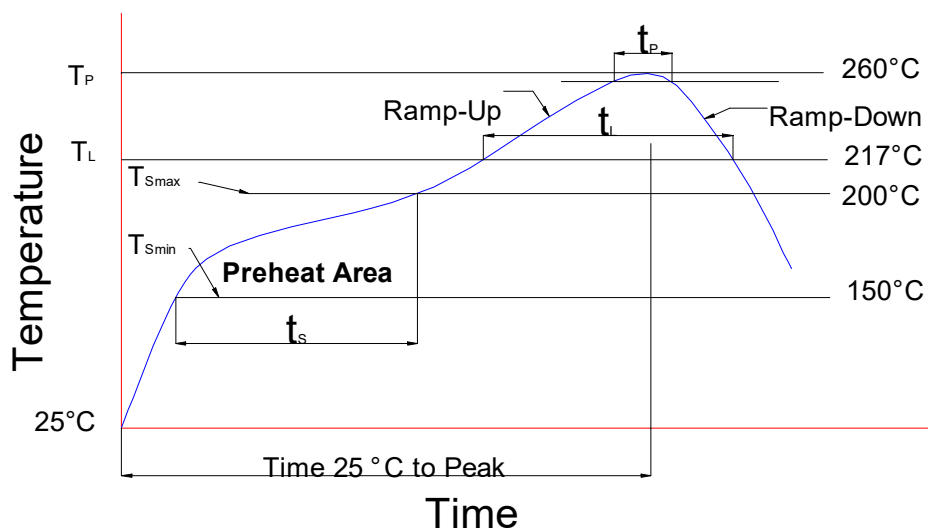


单位: mm

备注 Notes:

- ◇ 所有尺寸均以 mm 为单位
All dimensions are in millimeters
- ◇ 尺寸未按照公差±0.1mm 标记的, 按照图纸标记
Size is not marked in accordance with tolerance $\pm 0.1\text{mm}$ and dimension tolerances in accordance with drawings

8、回流焊特性 Reflow Soldering Characteristics

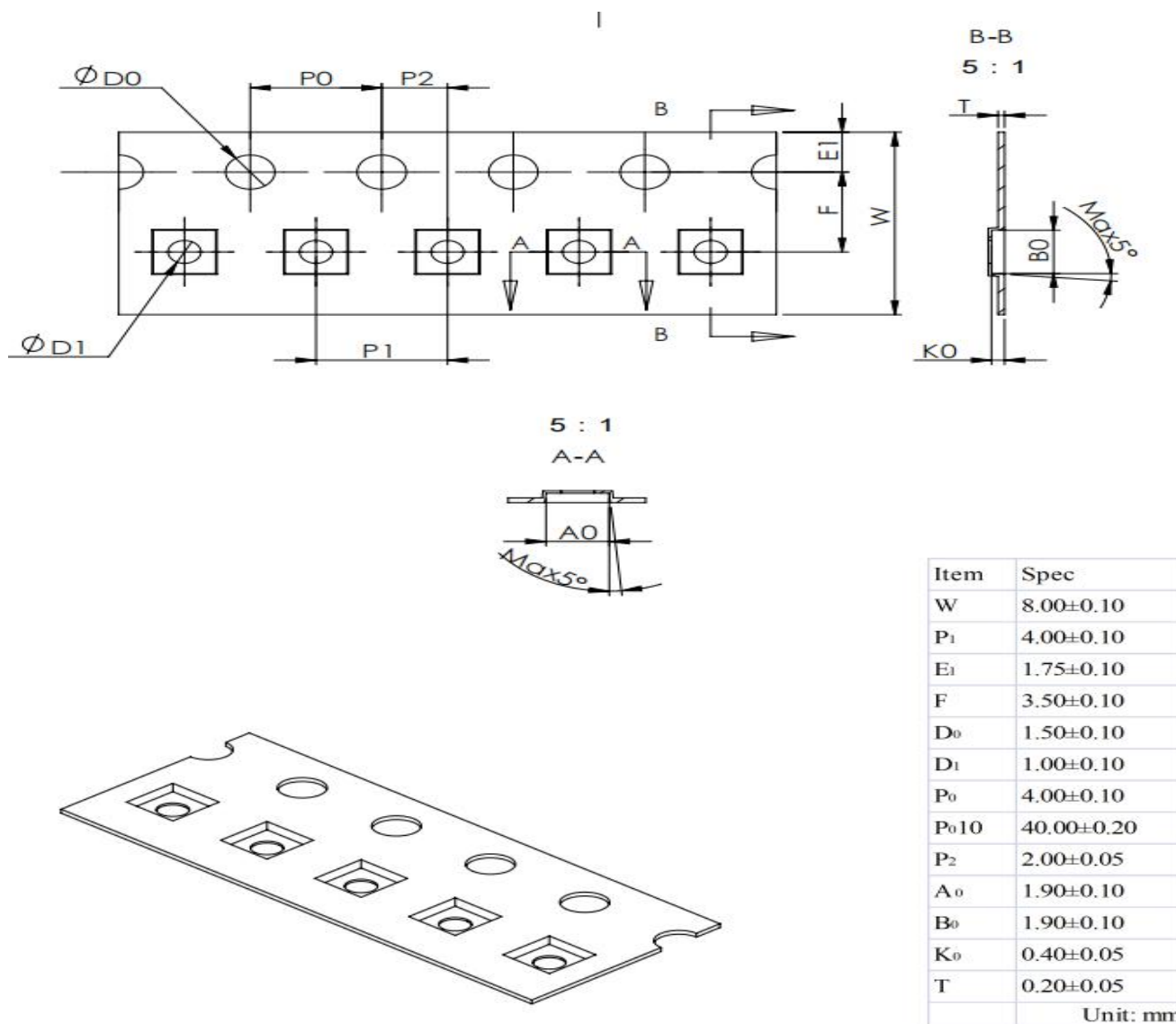


根据 EDEC-J-STD-020D 内容，参考以下内容。

Compatible with the JEDEC-J-STD-020D, using the parameters listed below.

特制参数 Profile Feature	无铅焊料 Lead-Free Solder
平均上升速率 (T _{Smax} 至 T _p) Average Ramp-Up Rate (T _{Smax} to T _p)	3 °C/sec max.
预热: 温度最小值 (T _{Smin}) Preheat: Temperature Min (T _{Smin})	150
预热: 最高温度 (T _{Smax}) Preheat: Temperature Max (T _{Smax})	200
预热: 时间 (t _{Smin} 到 t _{Smax}) Preheat: Time (t _{Smin} to t _{Smax})	60-120 secs
回流温度 (T _L) Time Maintained Above: Temperature (T _L)	217°C
回流时间 (t _L) Time Maintained Above: Time (t _L)	60-150 secs
峰值/分类温度 (T _p) Peak/Classification Temperature(T _p)	255±5°C
实际峰值温度 (t _p) 在 5°C 以内的时间 Time Within 5°C of Actual Peak Temperature (t _p)	5 secs
降低速率 Ramp-Down Rate	4°C/sec max.

9、卷轴 Reel Dimensions



备注 Notes:

- ✧ 卷轴包装最大 5000pcs
Reel: max 5000pcs.
- ✧ 卷轴包装方法符合 IJSC0806 (连续胶带上的电子元件包装)
The tape packing method complies with IJSC0806(Packing of Electronic Components on Continuous Tapes).
- ✧ 当卷轴由于工作中断而重绕时, 载带上压力不应超过 10N, 否则 LED 可能会粘在盖带上
When the tape is rewound due to work interruptions, no more than 10N should be applied to the embossed carrier tape.
The LEDs may stick to the cover tape.

10、可靠性 Reliability

a) 测试和结果 Tests and Results

测试项目 Test Item	参考标准 Reference Standard	测试条件 Test Conditions	测试周期 Test Duration	失效标准 Failure Criteria#	失效数/测试数 Units Failed/Tested
可焊性（回流焊） Solderability (Reflow Soldering)	JESD22-B102	$T_{sld}=255\pm 5^{\circ}\text{C}$, 5sec, Lead-free Solder(Sn-3.0Ag-0.5Cu)	5times	#2	0/22
高低温循环 Temperature Cycle	JESD22-A105	$I_F=900\text{mA}$, $-40^{\circ}\text{C}(30\text{min})\sim 25^{\circ}\text{C}(5\text{min})$ $\sim 80^{\circ}\text{C}(30\text{min})\sim 25^{\circ}\text{C}(5\text{min})$	100cycles	#1	0/22
高温/低温储存 High/Low Temperature Storage	JESD22-A119	$T_A=120^{\circ}\text{C}/T_A=-40^{\circ}\text{C}$	1000h	#1	0/22
高温老化 High Temperature Operating	JESD22-A108	$T_A=85^{\circ}\text{C}$, $I_F=900\text{mA}$	1000h	#1	0/22
高温高湿老化 Temperature Humidity Operating	JESD22- A101	85°C , $\text{RH}=85\%$, $I_F=900\text{mA}$	1000h	#1	0/22
振动 Vibration	JESD22-B103	200m/s^2 , 100~20000~100Hz, 4 cycles, 4min, each X, Y, Z	48cycles	#1	0/22

b) 失效判定 Failure Criteria

判定 Criteria #	项目 Items	条件 Conditions	失效判定 Failure Criteria
#1	正向电压 Forward Voltage (V_F)	I_F	> 初始值×1.1 倍 > Initial value×1.1
	光通量 Luminous Flux (Φ_v)	I_F	< 初始值×0.9 倍 < Initial value×0.9
	反向电流 Reverse Current (I_R)	$V_R=5V$	> 1uA > 1uA
#2	回流焊 Solderability	-	焊接面积<80% Less than 80% solder coverage

11、注意事项 Cautions

a) 存储 Storage

- 不要将芯片放在潮湿的地方，存放温度在 5°C~30°C之间，相对湿度在 30%以下。
Do not place the chips in damp places, Storage temperature between 5 °C and 30 °C, Relative humidity under 30%.
- 开包后建议在 24 小时内过完回流焊，车间条件≤30°C/60%RH。
After opening the package, it is recommended to finish the reflow within 24 hours. The workshop conditions are ≤30°C/60%RH
- 如果受潮，需将贴片卷盘放入 60°C烤箱烘烤 24 小时；打开后，LED 灯可重新密封在原始真空袋中。
If it is wet, the patch reel should be baked in a 60 ° C oven for 24 hours; after opening, the LED light can be resealed in the original vacuum bag.
- 不要接触任何未知的液体，特别是丙酮。
Don't touch any unknown liquid, In particular, acetone.
- 防止静电死亡，手动操作需要戴橡胶手套并佩戴静电环。
Prevent electrostatic killed, Manual operation is required to wear rubber gloves and wear electrostatic ring.

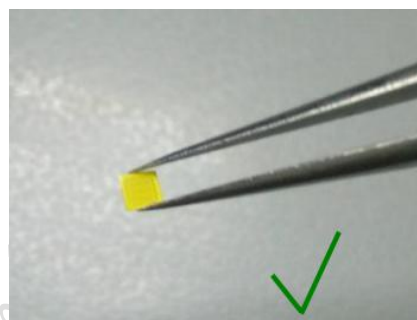
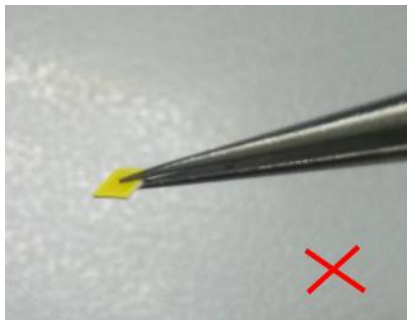
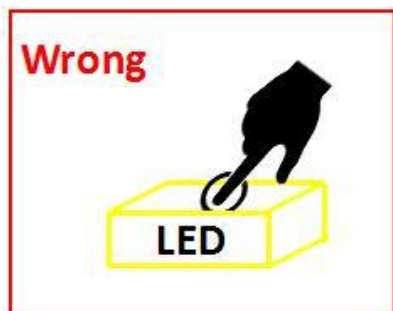
b) 清洗 Cleaning

- 通常，LED 不建议对部件进行湿式清洁处理，因为封装不是密封的。
In general, LED does not recommend a wet cleaning process for component as the package is not hermetically sealed.
- 由于采用开放式设计，所有类型的清洁液都可能渗透到封装中，导致 LED 退化或完全失效。
Due to the open design, all kind of cleaning liquids can infiltrate the package and cause a degradation or a complete failure of the LED.

c) 推荐吸嘴 Recommend Nozzle Dimensions

- 建议使用聚四氟乙烯等材料作为喷嘴，锐化钢材料拾取工具不建议使用
Recommend using Teflon material for the nozzle, sharpen steel material pick up tools are refused.

d) 操作注意 Handling Precautions



- 在处理过程中，还应注意确保组件顶面没有压力
During the handling, care should be taken as well to ensure no pressure on the top surface of component.
- 应避免使用所有类型的尖锐物体（例如镊子，指甲等），以防止对硅树脂造成压力，因为这会导致部件损坏。
All types of sharp objects(e.g. forceps, fingernail, etc) should be avoided in order to prevent stress to the silicone, since this can lead to damage of the component.